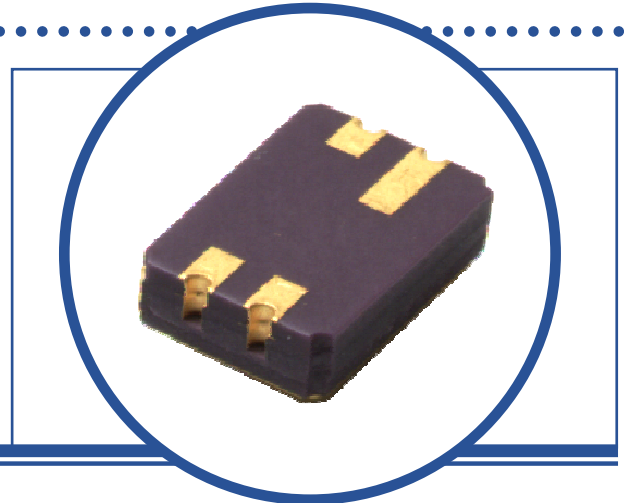


# P-CHANNEL ENHANCEMENT MODE MOSFET

## VP1008CSM4

- Low On-Resistance,  $R_{DS(on)}$
- Moderate Threshold,  $V_{GS(th)}$
- Low Input Capacitance,  $C_{ISS}$
- Fast Switching Speed
- Hermetic Ceramic Surface Mount Package
- Ideally Suited For Power Supply Circuits, Switching And Driver (Relay, Solenoid, Lamp etc.) Applications
- Screening Options Available



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise stated)

$V_{DS}$	Drain – Source Voltage		100V
$V_{GS}$	Gate – Source Voltage		$\pm 30\text{V}$
$I_D$	Continuous Drain Current	$T_A = 25^\circ\text{C}$	300mA
		$T_A = 100^\circ\text{C}$	195mA
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>		3A
$P_D$	Total Power Dissipation at	$T_A = 25^\circ\text{C}$	400mW
		Derate Above $25^\circ\text{C}$	3.2mW/ $^\circ\text{C}$
$T_J$	Operating Temperature Range		-55 to $+150^\circ\text{C}$
$T_{stg}$	Storage Temperature Range		-55 to $+150^\circ\text{C}$

### THERMAL PROPERTIES

Symbols	Parameters	Min.	Typ.	Max.	Units
$R_{\theta JA}$	Thermal Resistance, Junction To Ambient			312.5	$^\circ\text{C/W}$

#### Notes

(1) Repetitive Rating: Pulse width limited by maximum junction temperature

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## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise stated)

Symbols	Parameters	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0$ $I_D = -10\mu\text{A}$	-100	-110		V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = -1.0\text{mA}$	-2	-3.4	-4.5	V
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS} = \pm 20\text{V}$ $V_{DS} = 0\text{V}$ $T_J = 125^\circ\text{C}$			$\pm 100$	nA
					$\pm 500$	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -100\text{V}$ $V_{GS} = 0$ $T_J = 125^\circ\text{C}$			-10	$\mu\text{A}$
					-500	
$I_{D(ON)}^{(2)}$	On-State Drain Current	$V_{DS} = -15\text{V}$ $V_{GS} = -10\text{V}$	-1.1	-2		A
$R_{DS(on)}^{(2)}$	Static Drain-Source On-State Resistance	$V_{GS} = -10\text{V}$ $I_D = -1.0\text{A}$ $T_J = 125^\circ\text{C}$		2.5	5	$\Omega$
				4.3	8	
$g_{fs}^{(2)}$	Forward Transconductance	$V_{DS} = -10\text{V}$ $I_D = -0.5\text{A}$	200	325		m $\Omega$
$g_{os}^{(2)}$	Common Source Output Conductance	$V_{DS} = -7.5\text{V}$ $I_D = -0.1\text{A}$		0.45		

## DYNAMIC CHARACTERISTICS

$C_{iss}$	Input Capacitance	$V_{GS} = 0$ $V_{DS} = -25\text{V}$ $f = 1.0\text{MHz}$		75	150	pF
$C_{oss}$	Output Capacitance			40	60	
$C_{rss}$	Reverse Transfer Capacitance			18	25	
$t_{d(on)}$	Turn-On Time	$V_{DD} = -25\text{V}$ , $R_L = 47\Omega$ , $R_G = 50\Omega$ $I_D = -0.5\text{A}$ , $V_{GEN} = -10\text{V}$		7	15	ns
$t_r$				52	60	
$t_{d(off)}$	Turn-Off Time			40	50	
$t_f$				56	65	

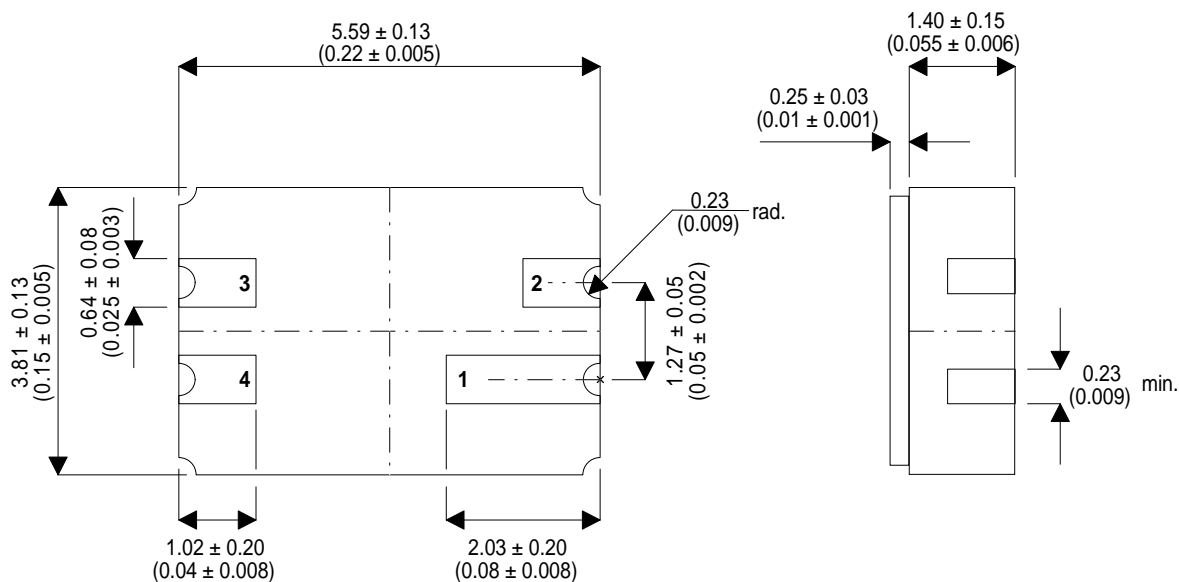
### Notes

(2) Pulse Width  $\leq 300\mu\text{s}$ ,  $\delta \leq 2\%$

# P-CHANNEL ENHANCEMENT MODE MOSFET VP1008CSM4

## MECHANICAL DATA

Dimensions in mm (inches)



### LCC3 PACKAGE (MO-041BA) Underside View

PAD 1 – Drain      PAD 3 – Source  
PAD 2 – N/C      PAD 4 – Gate